

Directional Coupler

TCD-9-1W-75+

75Ω

5 to 2000 MHz

FEATURES

- Wideband, 5 to 2000 MHz
- Low mainline loss, 1.3 dB typ. (5-1000 MHz)
- Aqueous washable
- · Leads for excellent solderability
- Protected by US Patent 6,140,887



Generic photo used for illustration purposes only

CASE STYLE: DB714

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- GPS
- Cellular
- Satellite distribution
- CATV

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit	
Frequency Range	_	5	_	2000	MHz	
	5-50	_	1.3	2.1		
Mainline Least (shears the continue O.1 dD)	50-500	_	1.3	2.0	.ID	
Mainline Loss¹ (above theoretical 0.1 dB)	500-1000	_	1.8	2.4	dB	
	1000-2000	_	2.5	_		
Coupling	5-1000	_	8.9±0.5	_	dB	
Coupling	1000-2000	_	8.5±0.5	_	ав	
Coupling Flatness (±)	5-2000	_	±0.6	_		
	5-50	17	21	_		
Directivity	50-500	_	15	_	dB	
Breedivity	500-1000	_	10	_	QD.	
	1000-2000	_	10	_		
VSWR	5-1000	_	1.30	_	:1	
VSVVI	1000-2000	_	1.60	_	.1	
Input Dower	5-1000	_	_	0.5	W	
Input Power	1000-2000	_	_	1.0	v v	

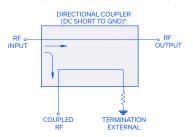
 $^{{\}bf 1.}\ {\bf Mainline}\ {\bf loss}\ {\bf includes}\ {\bf theoretical}\ {\bf power}\ {\bf loss}\ {\bf at}\ {\bf coupled}\ {\bf port}.$

MAXIMUM RATINGS

Parameter	Ratings				
Operating Temperature	-40°C to 85°C*				
Storage Temperature	-55°C to 100°C				

Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



*Electrical schematic is for Directiona coupler with internal transformer(s) and external termination

^{*} Case temperature is defined as temperature on ground leads.



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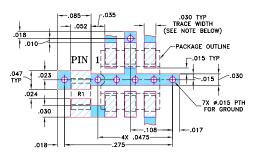
5 to 2000 MHz

PIN CONNECTIONS

INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
75Ω TERM EXTERNAL	6
NOT USED	5

PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-72 **SUGGESTED PCB LAYOUT** (PL-010)



RESISTOR R1: 75 ± 1% Ohm, 0805 SIZE

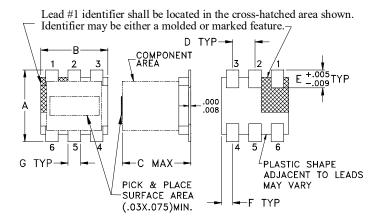
 $\frac{\text{NOTES:}}{\text{THICKNESS 0.030"}} \text{ 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030"} \pm 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED$

- TO BE MODIFIED.

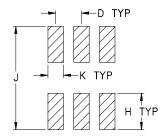
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches)

F	Е	D	С	В	Α
.025	.040	.050	.160	.150	.160
0.64	1.02	1.27	4.06	3.81	4.06
wt		K	J	Н	G
grams		.030	.190	.065	.028
0.15		0.76	4.83	1.65	0.71

TAPE & REEL INFORMATION: F47



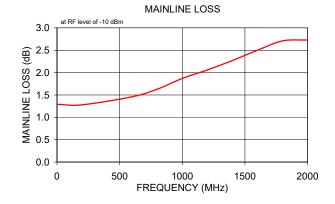
SURFACE MOUNT Directional Coupler TCD-9-1W-75+

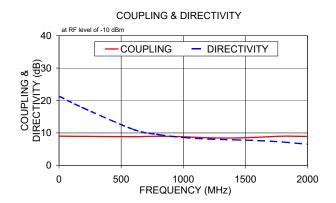
75Ω

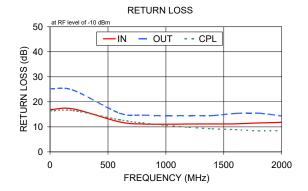
5 to 2000 MHz

TYPICAL PERFORMANCE DATA

Frequency	Mainline Loss (dB)	Coupling (dB)	Directivity (dB)	Return Loss (dB)		
(MHz)	In-Out	In-CpI		In	Out	Cpl
5.00	1.29	8.99	21.24	16.92	25.24	16.42
200.00	1.28	8.94	17.61	17.17	24.67	16.49
600.00	1.46	8.84	11.06	12.00	15.49	12.84
800.00	1.63	8.98	9.49	11.14	14.69	11.57
1000.00	1.87	8.81	8.59	11.05	14.44	10.62
1200.00	2.06	8.50	8.12	11.15	14.53	9.81
1400.00	2.27	8.43	7.88	11.16	14.51	9.22
1600.00	2.50	8.66	7.63	11.20	15.36	8.91
1800.00	2.71	9.00	7.19	11.56	15.46	8.40
2000.00	2.73	8.92	6.49	11.81	14.35	8.53







- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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Case Style

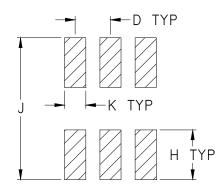


DB714

Outline Dimensions

SEE NOTE 3 D TYP→ SEE NOTE 3 COMPONENT AREA +.005 Ε -.009.000 .008 5 G TYP C MAX→ ^LPLASTIC SHAPE ADJACENT TO LEADS PICK & PLACE MAY VARY SURFACE AREA (.03X.075)MIN.

PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	E	F	G	Н	J	K	WT. GRAM
DB714	.160	.150	.160	.050	.040	.025	.028	.065	.190	.030	15
DB/14	(4.06)	(3.81)	(4.06)	(1.27)	(1.02)	(0.64)	(0.71)	(1.65)	(4.83)	(0.76)	.13

Dimensions are in inches (mm). Tolerances: 2 Pl. \pm .01; 3Pl. \pm .005

Notes:

- 1. Case material: Plastic.
- 2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix. For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

3. Lead #1 identifier shall be located in the cross-hatched area shown. Identifier may be either a molded or marked feature.



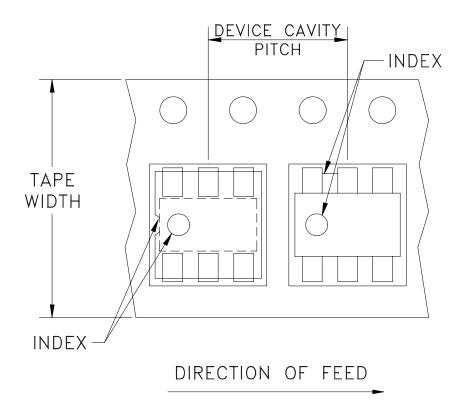


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



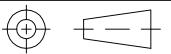
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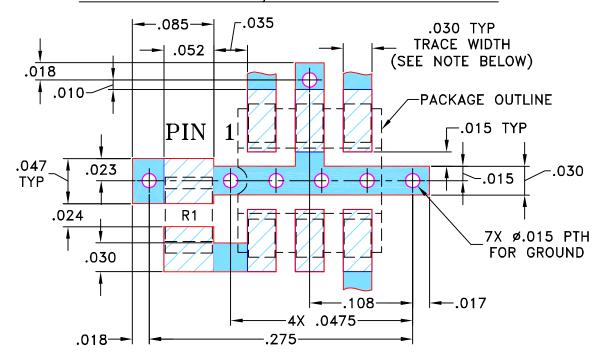
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THIRD ANGLE PROJECTION



		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M73159	NEW RELEASE	08/00	IL	DB
A	M82377	UPDATED DRAWING	07/30/02	AV	LC
В	M102713	UPDATED NOTES	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR DB714 CASE STYLE, "mm" PIN CONNECTION



RESISTOR R1: 75 \pm 1% Ohm, 0805 SIZE

- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 - 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



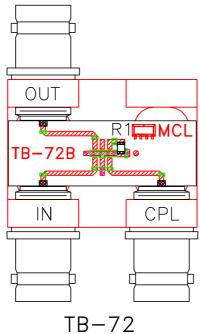
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

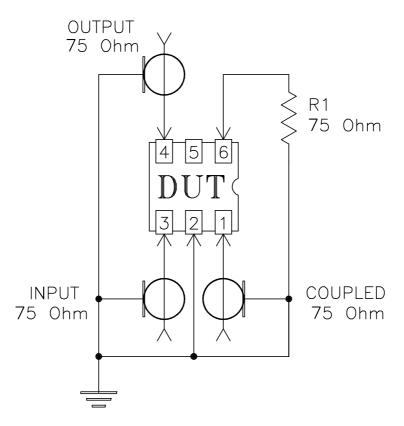


DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE		7 3 6			• 4 (R)			
DIMENSIONS ARE IN INCHES	DRAWN	IL	08/03/00		\perp Mini	ı—(ircu	1ts 13.1	Neptur	ne Aver NY 112	iue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	WP	08/08/00					Бгос		NI IIA	200
3 PL DECIMALS ± .005	APPROVED	DB	08/09/00								
FRACTIONS ±				PL	mm,	75.	DB714	TCD.	T	B-	72
Mini	-Circuits ®				,,	,		, ,			
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Evaluation Board and Circuit

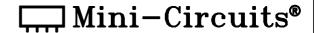




Schematic Diagram

Notes:

- 1. 75 Ohm BNC Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.





Environmental Specifications

ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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